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PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant : Van Steenkiste et al.  
Appl. No. : 09/744,465  
Filed : April 16, 2001  
For : SYSTEM AND A METHOD FOR  
PLATING OF A CONDUCTIVE  
PATTERN  
Examiner : Brian L. Mutschler  
Group Art Unit : 1753

# 7/wm.  
10/2/03

RESPONSE

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Dear Sir:

In response to the Office Action dated May 22, 2003, Applicant respectfully requests that the Examiner enter the following amendments and consider the following remarks.

**Amendments to the Specification** begin on page 2 of this paper.

**Amendments to the Claims** are reflected in the listing of claims which begins on page 9 of this paper.

**Amendments to the Drawings** begin on page 11 of this paper.

**Remarks/Arguments** begin on page 12 of this paper.

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